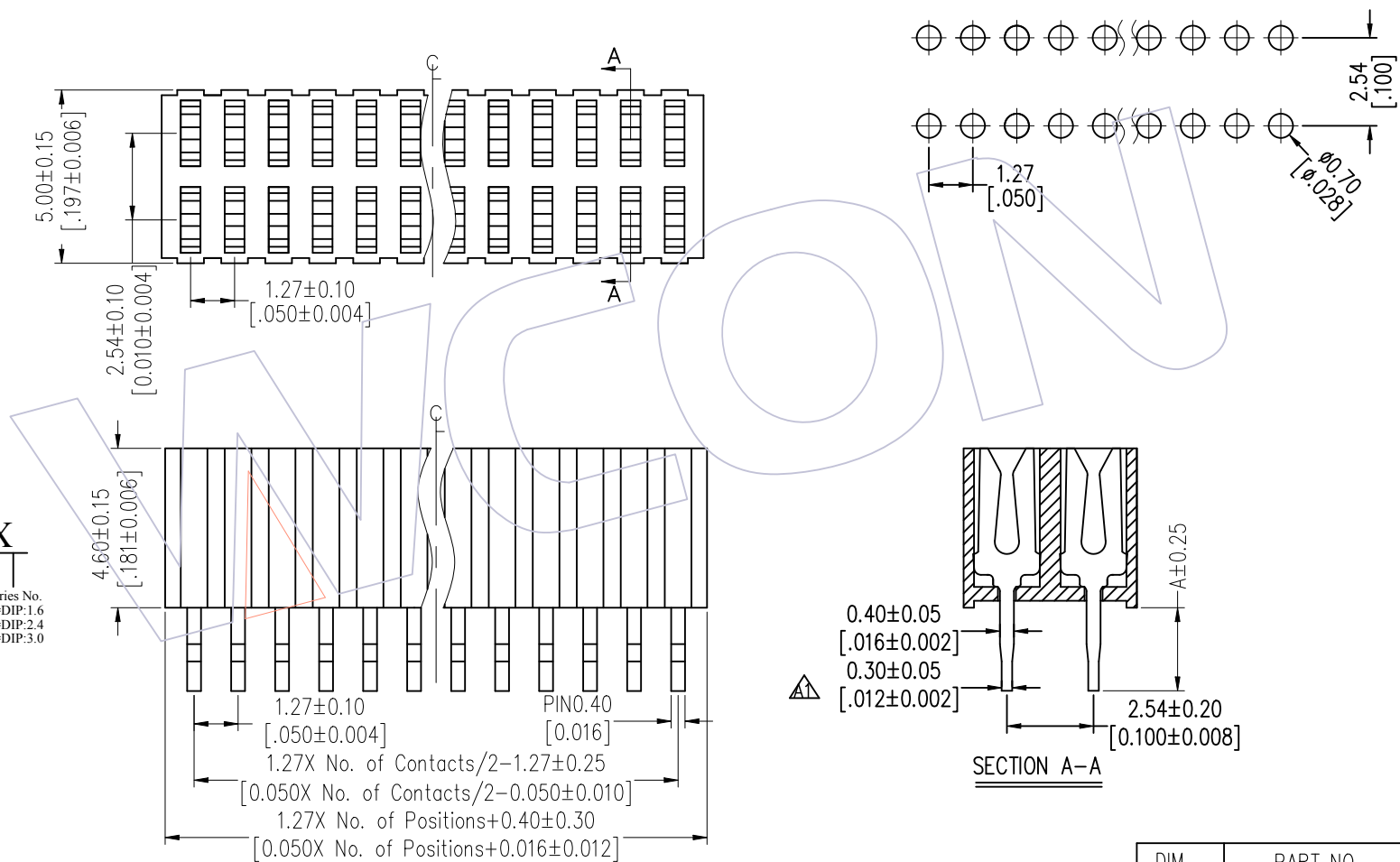


# HSF

NOTES:  
 Current Rating: 1.0AMP  
 Contact Resistance: 20mΩ Max  
 Withstand Voltage: 500V AC/DC  
 Insulation Resistance: 1000MΩ Min  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au over Ni  
 Insulator Material: PA9T+30%GF UL94V-0

Recommended P.C.B Layout (Top Side)  
 (PCB BOARD TOLERANCE ±0.05)



## Ordering Information

2446-2 XX S XX CYN T X

No. of Pins per Row: 02-50Pin

Contact Plating:  
 G0=Gold Flash  
 G3=10μ"Gold  
 G4=15μ"Gold  
 G5=30μ"Gold

Packing:  
 T=Tube

Series No.  
 1=DIP:1.6  
 2=DIP:2.4  
 3=DIP:3.0

Item	Pitch	Mating
Standard	1.27	1417/1425
Alternate		

DIM	PART NO.
A=1.6	2446-2XXSXXCYNT1
A=2.4	2446-2XXSXXCYNT2
A=3.0	2446-2XXSXXCYNT3

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
				x.x ±0.40	Wang	2013/11/11	UNIT mm		SEE TABLE
A1	2013/11/11	ADD DIM: 0.30	-----	x.xx ±0.25	CHECK	DATE	SIZE A4		TITLE: FH1. 27x2.54mm DUAL Row 180° DIP H=4.60
A0	2012/07/10	NEW	-----	x.xxx ±0.15			SHEET 1/1		
				Angle ± 3°	APPROVE	DATE	PROJ.		Customer NO.
				DIM TOL					

# WCON

Http: www.wcon.com

WCON-Dongguan Tel: +86 769 85358920 Fax: +86 769 85358915 E-mail: sales@wcon.com  
 WCON-Kunshan Tel: +86 512 57468408 Fax: +86 512 57468468 E-mail: salesks@wcon.com